



General Description

The SJZ012N04 uses SGT technology to provide excellent $R_{DS(ON)}$, low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

Features

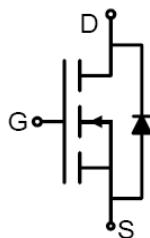
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

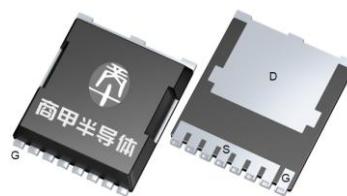
- DC/DC Converter
- Load Switching, Quick/Wireless Charging, Motor Driving

Key Performance Parameters

| Parameter | Value | Unit |
|-------------------|-------|-----------|
| V_{DS} | 40 | V |
| $R_{DS(ON)}_TYP$ | 0.9 | $m\Omega$ |
| I_D | 304 | A |
| Q_G | 101 | nC |



Schematic Diagram



TOLL top&bottom view

Package Marking and Ordering Information

| Device/Ordering Code | Marking | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|-----------|---------|---------|-----------|------------|----------|
| SJZ012N04 | SJZ012N04 | TOLL | Tape | \ | \ | 2000 Pcs |

Table 1. Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Limit | Unit |
|------------------|---|------------|------|
| V_{DS} | Drain-Source Voltage ($V_{GS}=0V$) | 40 | V |
| V_{GS} | Gate-Source Voltage ($V_{DS}=0V$) | ± 20 | V |
| I_D | Drain Current-Continuous($T_c=25^\circ C$) | 304 | A |
| | Drain Current-Continuous($T_c=100^\circ C$) | 192 | A |
| I_{DM} (pulse) | Drain Current-Continuous@ Current-Pulsed (Note 1) | 1216 | A |
| P_D | Maximum Power Dissipation($T_c=25^\circ C$) | 167 | W |
| | Maximum Power Dissipation($T_c=100^\circ C$) | 67 | W |
| E_{AS} | Avalanche energy (Note 2) | 812 | mJ |
| T_J, T_{STG} | Operating Junction and Storage Temperature Range | -55 To 150 | °C |

Table 2. Thermal Characteristic

| Symbol | Parameter | Typ | Max | Unit |
|-----------|--------------------------------------|-----|------|------|
| R_{eJC} | Thermal Resistance, Junction-to-Case | | 0.75 | °C/W |



40V N-Channel SGT Power MOSFET

Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|-----------------------------------|---|-----|------|-----------|------------------|
| On/Off States | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$ | 40 | | | V |
| $I_{\text{DS}}^{\text{SS}}$ | Zero Gate Voltage Drain Current | $V_{\text{DS}}=40\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$ | | | 1 | μA |
| | | $V_{\text{DS}}=40\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$ | | | 100 | μA |
| I_{GSS} | Gate-Body Leakage Current | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | | | ± 100 | nA |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$ | 1 | | 2.5 | V |
| g_{FS} | Forward Transconductance | $V_{\text{DS}}=5\text{V}$, $I_{\text{D}}=20\text{A}$ | | 66 | | S |
| $R_{\text{DS(ON)}}$ | Drain-Source On-State Resistance | $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$ | | 0.9 | 1.1 | $\text{m}\Omega$ |
| $R_{\text{DS(ON)}}$ | Drain-Source On-State Resistance | $V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$ | | 1.1 | 1.5 | $\text{m}\Omega$ |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=20\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$ | | 6112 | | pF |
| C_{oss} | Output Capacitance | | | 2137 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 130 | | pF |
| R_g | Gate resistance | $V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$ | | 1.8 | | Ω |
| Switching Parameters | | | | | | |
| $t_{\text{d(on)}}$ | Turn-on Delay Time | $V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $R_L=1\Omega$, $R_{\text{GEN}}=3\Omega$ | | 19.6 | | nS |
| t_r | Turn-on Rise Time | | | 27.6 | | nS |
| $t_{\text{d(off)}}$ | Turn-Off Delay Time | | | 85 | | nS |
| t_f | Turn-Off Fall Time | | | 31 | | nS |
| Q_g | Total Gate Charge | $V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=20\text{A}$ | | 101 | | nC |
| Q_{gs} | Gate-Source Charge | | | 16 | | nC |
| Q_{gd} | Gate-Drain Charge | | | 17.2 | | nC |
| Source-Drain Diode Characteristics | | | | | | |
| I_{SD} | Source-Drain Current (Body Diode) | | | | 304 | A |
| V_{SD} | Forward on Voltage (Note 3) | $V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=20\text{A}$ | | | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | | 65.2 | | ns |
| Q_{rr} | Reverse Recovery Charge | $I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | | 74.9 | | nC |

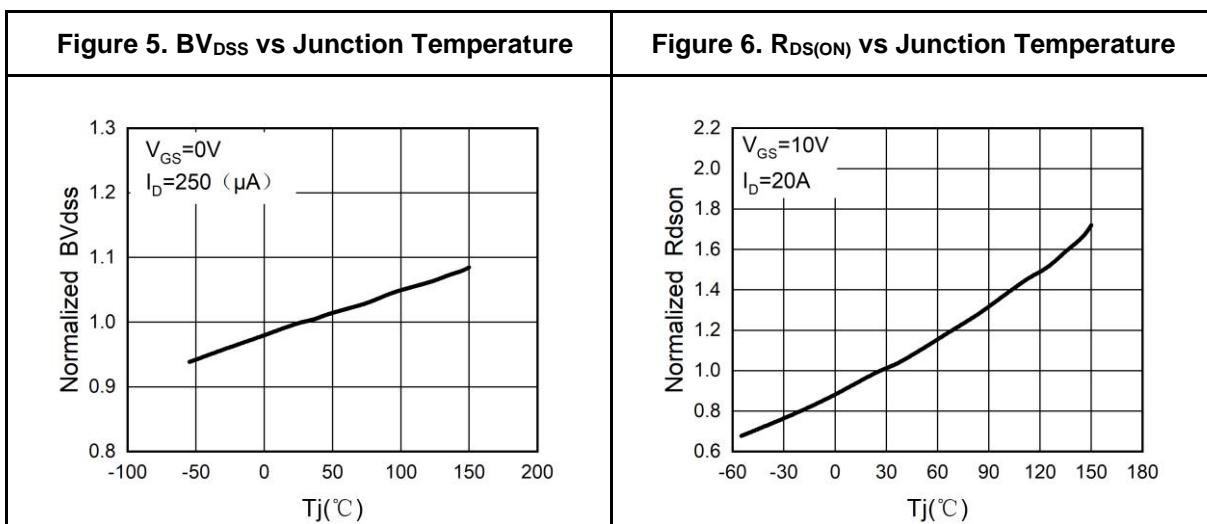
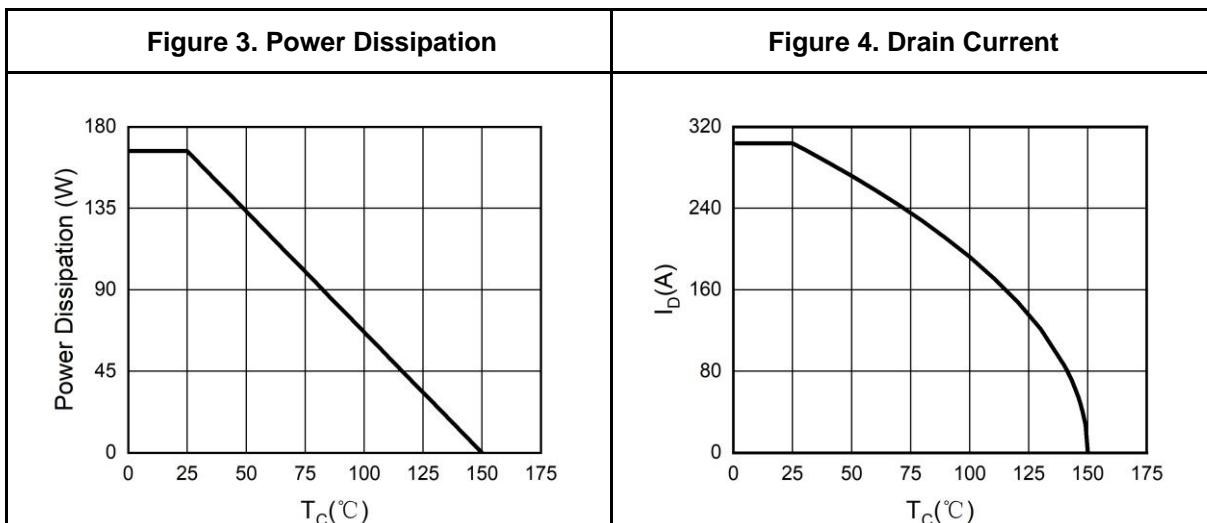
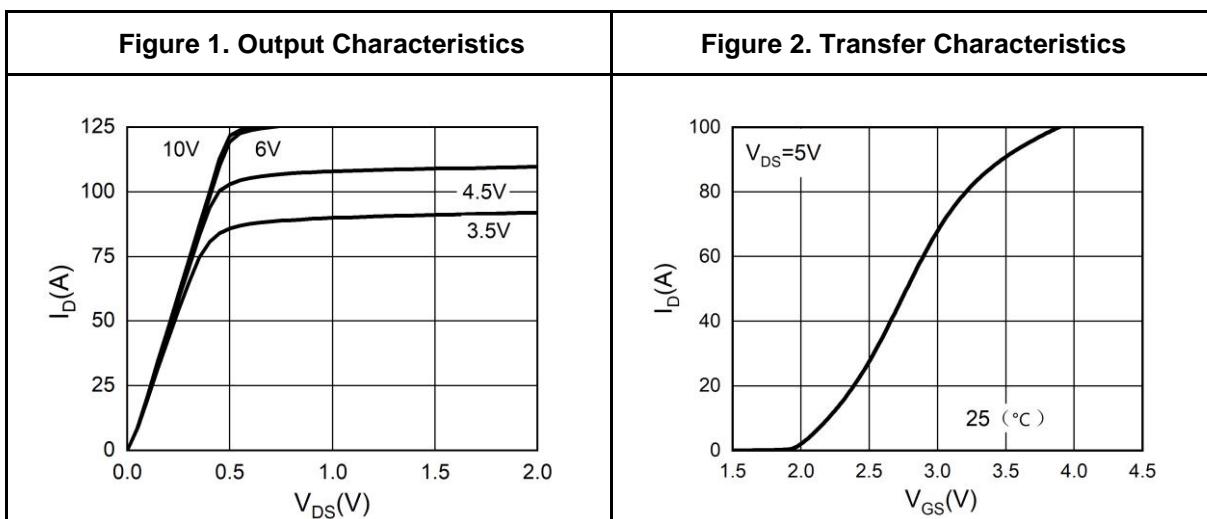
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=40\text{V}$, $V_G=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

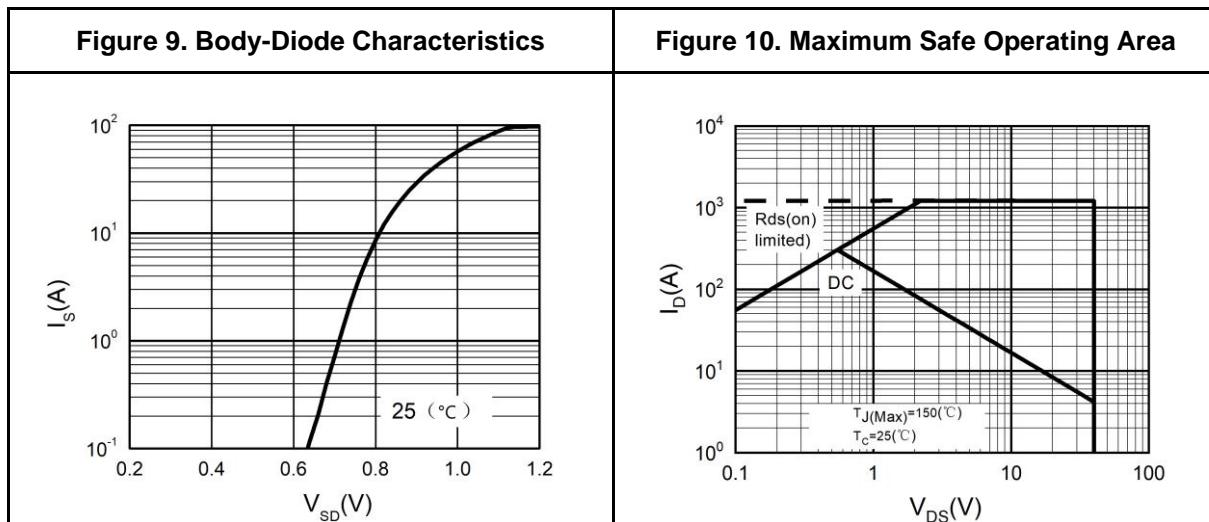
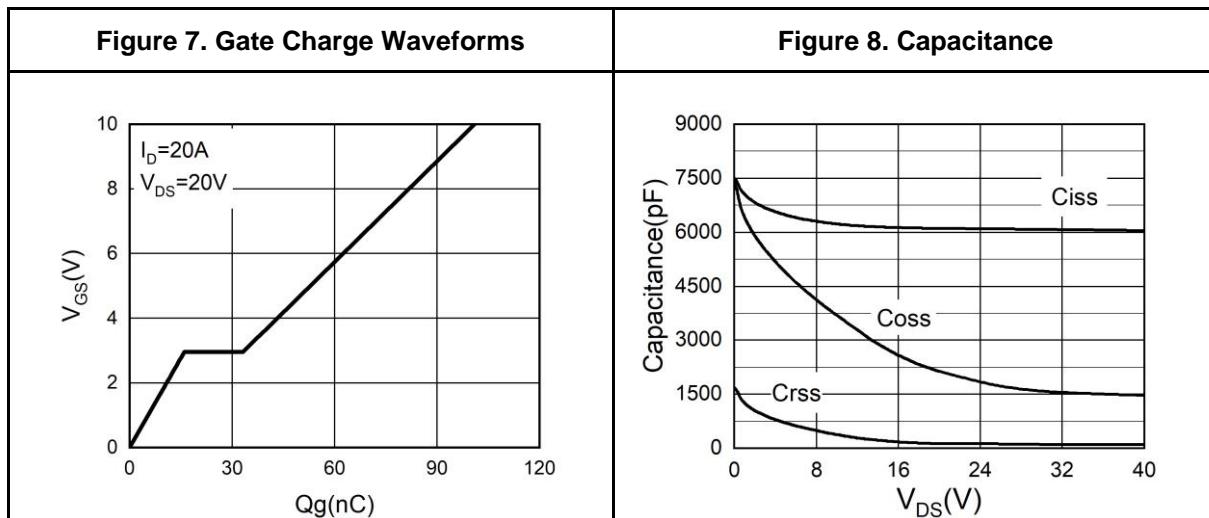


Typical Electrical And Thermal Characteristics (Curves)



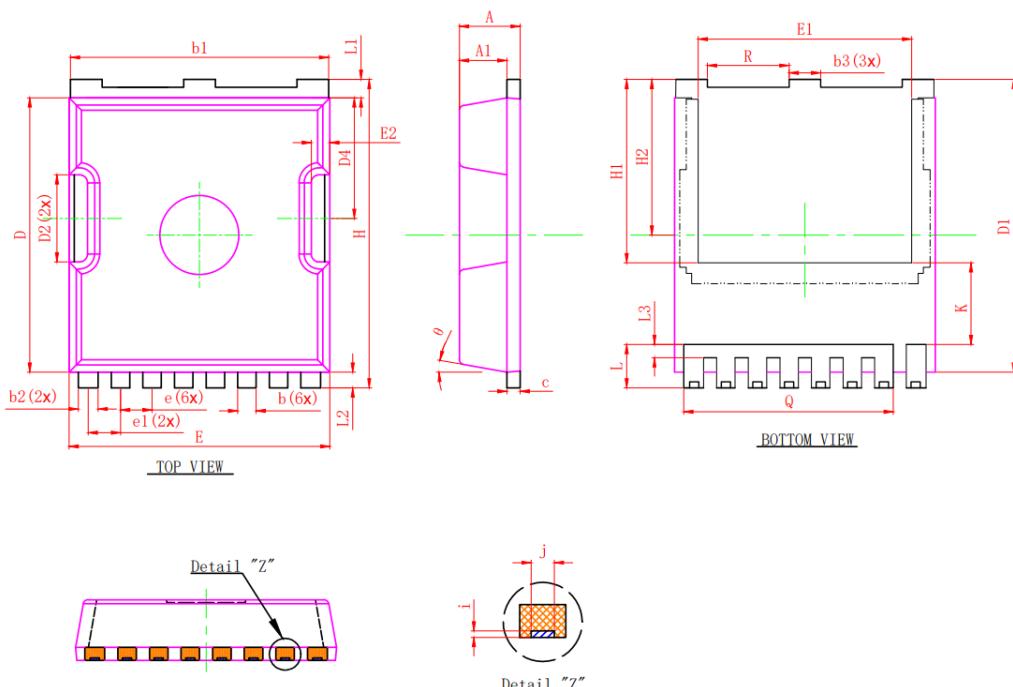


Typical Electrical And Thermal Characteristics (Curves)





TOLL Package Information



| SYMBOL | MILLIMETER | | |
|--------|------------|--------|--------|
| | MIN. | NOM. | MAX. |
| A | 2.200 | 2.300 | 2.400 |
| A1 | 1.700 | 1.800 | 1.900 |
| b | 0.600 | 0.700 | 0.800 |
| b1 | 9.700 | 9.800 | 9.900 |
| b2 | 0.650 | 0.750 | 0.850 |
| b3 | 1.100 | 1.200 | 1.300 |
| c | 0.400 | 0.500 | 0.600 |
| D | 10.300 | 10.400 | 10.500 |
| D1 | 11.000 | 11.100 | 11.200 |
| D2 | 3.200 | 3.300 | 3.400 |
| D4 | 4.470 | 4.570 | 4.670 |
| E | 9.800 | 9.900 | 10.000 |
| E1 | 8.000 | 8.100 | 8.200 |
| E2 | 0.500 | 0.600 | 0.700 |
| e | 1.200 BSC | | |
| e1 | 1.225 BSC | | |
| H | 11.600 | 11.700 | 11.800 |
| H1 | 6.950 BSC | | |
| H2 | 5.900 BSC | | |
| i | 0.100 REF. | | |
| j | 0.350 REF. | | |
| K | 3.100 REF. | | |
| L | 1.550 | 1.650 | 1.750 |
| L1 | 0.600 | 0.700 | 0.800 |
| L2 | 0.500 | 0.600 | 0.700 |
| L3 | 0.400 | 0.500 | 0.600 |
| Q | 7.950 REF. | | |
| R | 3.000 | 3.100 | 3.200 |
| θ | 10° REF. | | |



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